# 5-104178-5 ACTIVE

#### AMPMODU | AMPMODU System 50

TE Internal #: 5-104178-5

PCB Mount Header, Vertical, Board-to-Board, 8 Position, 1.27 mm [. 05 in] Centerline, Unshrouded, Gold (Au), Through Hole - Solder,

AMPMODU System 50

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 8

Number of Rows: 1

#### **Features**

#### **Product Type Features**

PCB Connector Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Unshrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

#### **Configuration Features**

Connector Contact Load Condition	Fully Loaded
Board-to-Board Configuration	Parallel
PCB Mount Orientation	Vertical
Number of Positions	8
Number of Rows	1

#### **Electrical Characteristics**

Operating Voltage	30 VAC
Insulation Resistance	5000 ΜΩ
Dielectric Withstanding Voltage (Max)	500 VAC

#### **Body Features**

Primary Product Color	Black
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#### **Contact Features**

Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Mating Square Post Dimension	.38 mm[.015 in]
PCB Contact Termination Area Plating Material Thickness	3.81 – 6.35 μm[150 – 250 μin]
Contact Shape & Form	Rectangular
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Pin
Contact Current Rating (Max)	3.6 A

#### **Termination Features**

Termination Post & Tail Diameter	.38 mm[.015 in]
Termination Post & Tail Length	2.54 mm[.1 in]
Termination Method to PCB	Through Hole - Solder

#### Mechanical Attachment

PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without

### **Housing Features**

Housing Material	LCP
Centerline (Pitch)	1.27 mm[.05 in]

#### **Dimensions**

## **Usage Conditions**

Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

### Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal



#### **Industry Standards**

Compatible With Agency/Standards Products	CSA, UL
UL Rating	Recognized
Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	200
Packaging Method	Box, Carton

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**



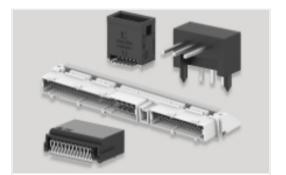




## Also in the Series | AMPMODU System 50



Board-to-Board Headers & Receptacles(685)



PCB Headers & Receptacles(685)



Rectangular Power Connectors(47)



Wire-to-Board Headers & Receptacles (47)

## Customers Also Bought



TE Part #284418-E STVB/3 20 F AB VV 7-00 EE 5,5 \* 247 E007



TE Part #6450820-2 MBXLE VERT HDR 1P+24S+1P



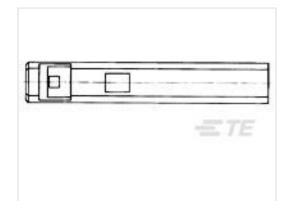
TE Part #2007820-2 IMP100S,H,V4P10C,UG,OEW39,4.9



TE Part #2057419-2 IMP100S,H,V2P10C,LG,OEW39,4.9



TE Part #294919-E SRCP 1,27 10 M 1 SMD 137 E1 094 \* GU-H \*



TE Part #926657-7
7P LOCKG CLIP GEH



TE Part #3-1461491-3 PCN-112D3MHZ,000





TE Part #867052-2 LOCKING CLIP CONT ASSY .025 SQ



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### **Documents**

**Product Drawings** 

08 SYS 50 HDR SRST UNSHRD SN

English

Datasheets & Catalog Pages

AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION3AND4

English

**Product Specifications** 

**Application Specification** 

English